

SID

Factory: Rot am See

Article:

ML6

Provided:

Customer:

Date:

03.04.2026

WÜRTH
ELEKTRONIK
MORE THAN
YOU EXPECT

Processtechnology: B: undefined

Material Text	Mat. Nr.	µm	Stackup	Process overview
---------------	----------	----	---------	------------------

A-RS Kupferfolie-018my 330x490mm	50200238	18	VS	1	
A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B...	50203002	366		2	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0		3	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		4	
		70	L2		
C-RaS-FR4-DS-0.991mm-070+070-TG150-HF...	50203142	850		5	A01
		70	L3		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	289		6	
A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B...	50203002	0		7	
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	0		8	
		70	L4		
C-RaS-FR4-DS-0.991mm-070+070-TG150-HF...	50203142	850		9	A02
		70	L5		
C-RAS-FR4-PP-1080-H63-TG150-HF-EM-37B...	50203000	366		10	
C-RAS-FR4-PP-2116-H53-TG150-HF-EM-37B...	50203001	0		11	
A-RAS-FR4-PP-7628-H45-TG150-HF-EM-37B...	50203002	0		12	
A-RS Kupferfolie-018my 330x490mm	50200238	18	RS	13	

B00:

Thickness after Pressing

B00:

3090 µm

Tol+:

320 µm

Tol-:

320 µm

Dmax:

3410 µm

Dmin:

2770 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

3200 µm

Tol+:

320 µm

Tol-:

320 µm

Dmax:

3520 µm

Dmin:

2880 µm

Measuring point: (05) over SM and galv. Cu; both sides

nominal:

3037 µm

Version 1.2.20.35

© Würth Elektronik